**Features:**

- n High speed switching
- n Higher system efficiency
- n Soft current turn-off waveforms
- n Square RBSOA using Trench-Fs technology

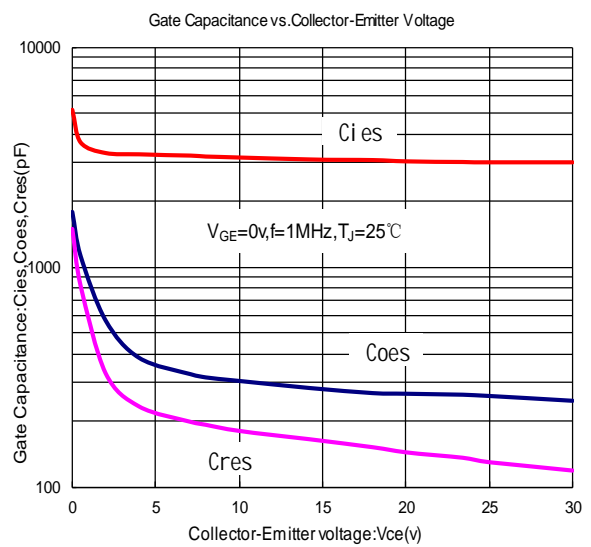
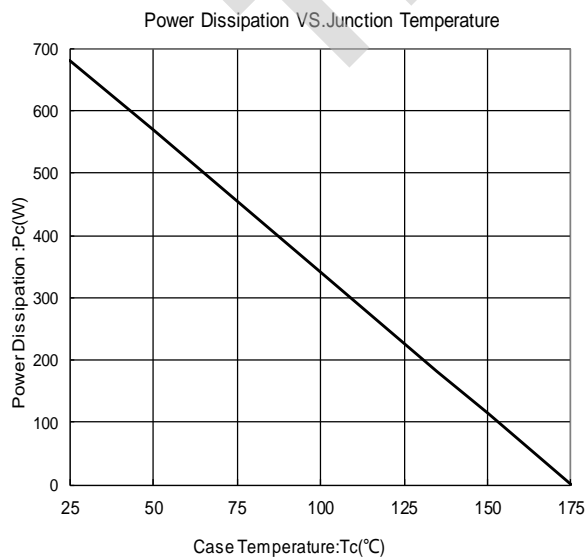
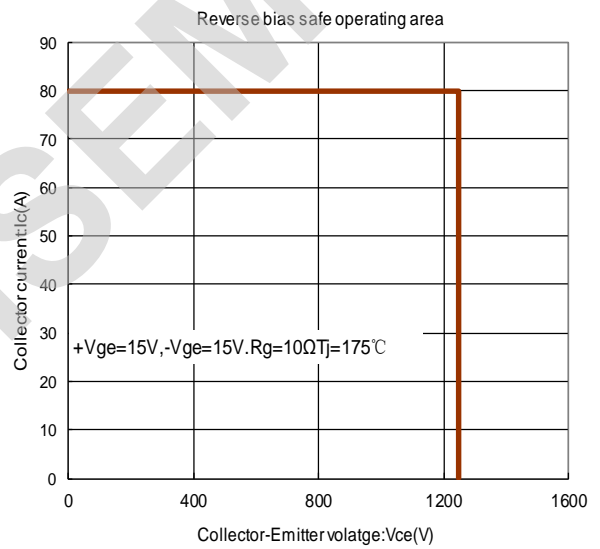
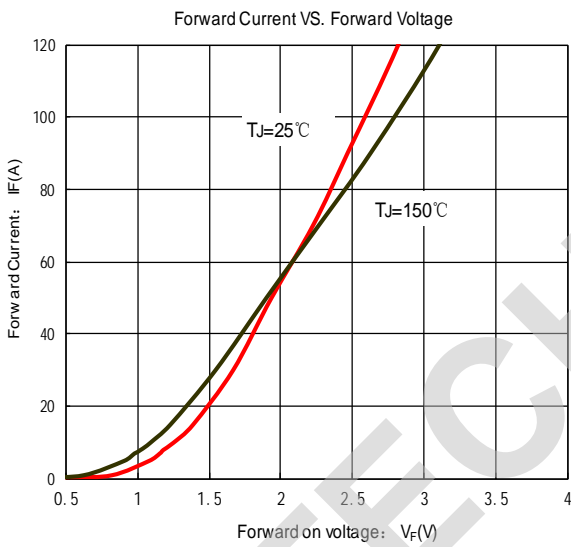
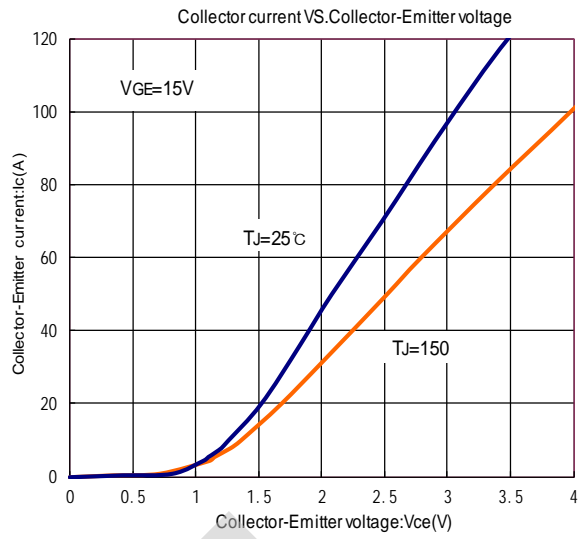
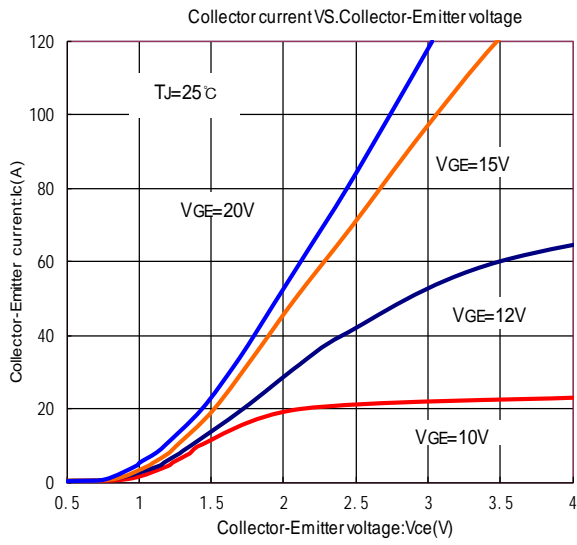
**Typical Applications:**

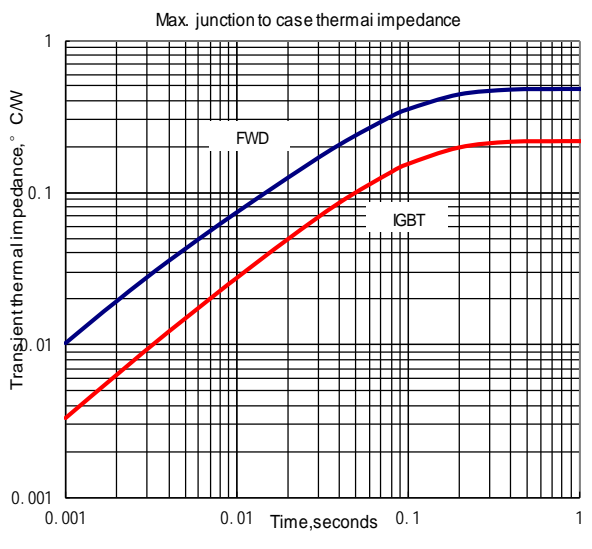
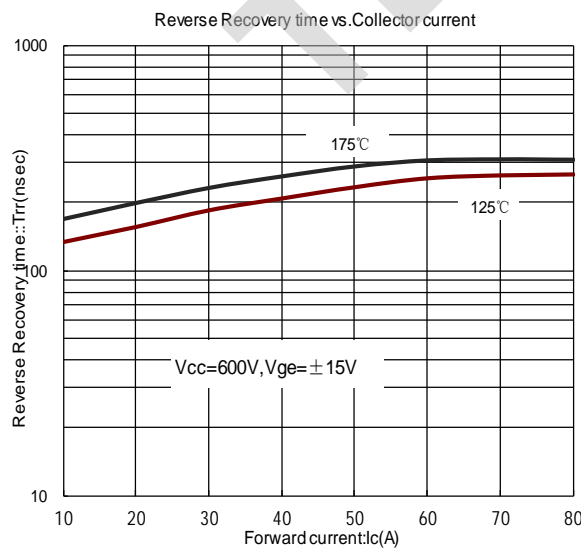
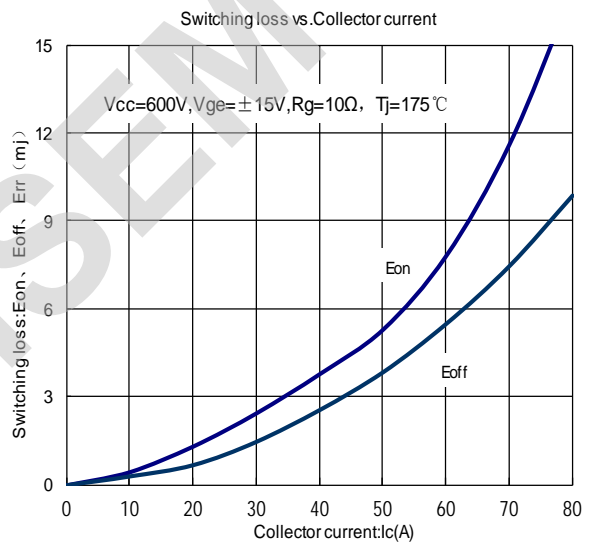
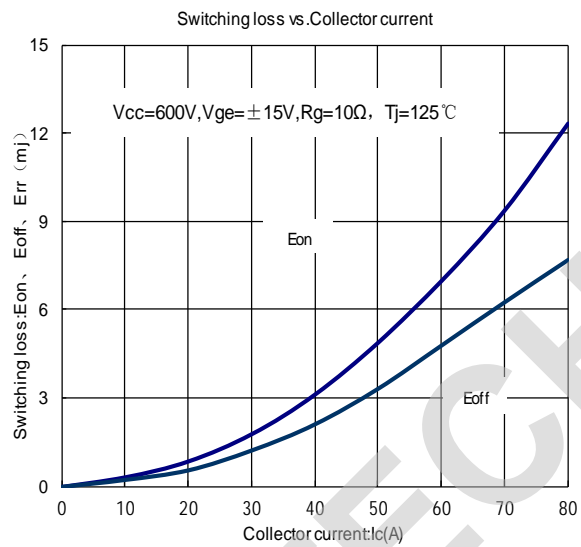
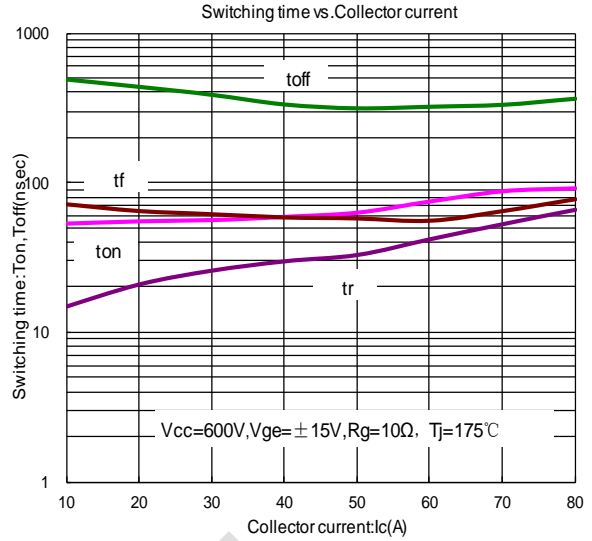
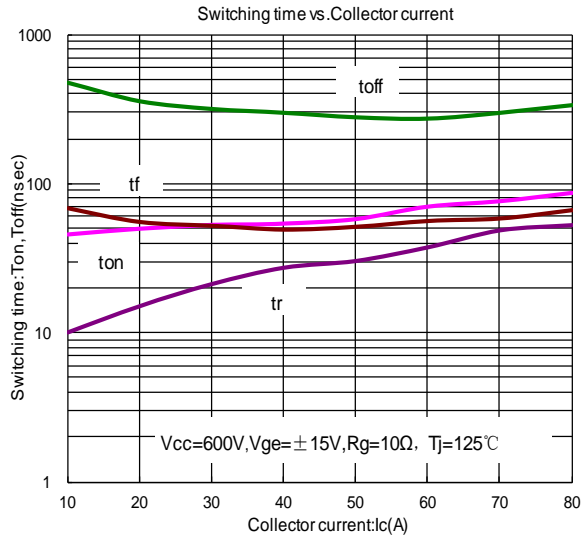
- n Inverter for motor drive(VFD)
- n AC and DC servo drive amplifier
- n UPS

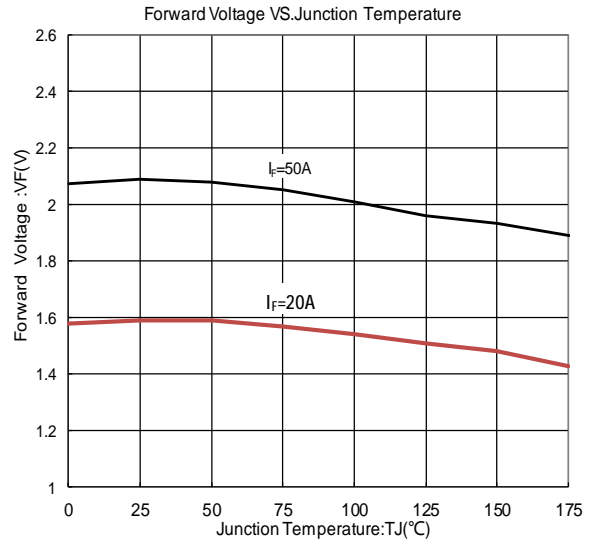
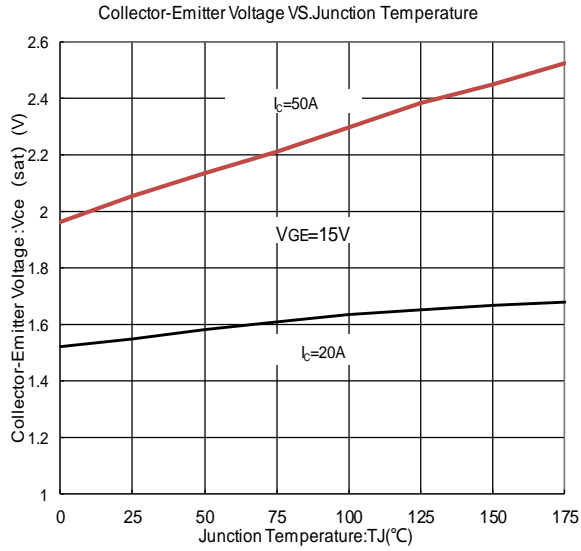
SYMBOL	CHARACTERISTIC	TEST CONDITIONS	VALUE			UNIT	
			Min	Type	Max		
$V_{CES}$	Collector-Emitter voltage	$T_j=25^\circ\text{C}$			1200	V	
$V_{GES}$	Gate-Emitter voltage	$T_j=25^\circ\text{C}$			$\pm 30$	V	
$I_C$	Continuous Collector current	$T_C=25^\circ\text{C}$			100	A	
		$T_C=135^\circ\text{C}$			50	A	
$I_{CP}$	DC collector current, limited by $T_{vjmax}$	$T_P=1\text{ms}$			200	A	
$P_C$	Power dissipation	$T_j=135^\circ\text{C}$			181	W	
$T_j$	Junction temperature	/	-40		175	$^\circ\text{C}$	
$T_{stg}$	Storage temperature	/	-40		150	$^\circ\text{C}$	
$T_L$	Lead Temperature (Soldering, 10 sec)				260	$^\circ\text{C}$	
$I_{CES}$	Zero gate voltage collector current	$T_j=25^\circ\text{C}, V_{CE}=1200\text{V}, V_{GE}=0\text{V}$			350	$\mu\text{A}$	
$I_{GES}$	Gate-Emitter leakage current	$T_j=25^\circ\text{C}, V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}$			$\pm 100$	nA	
$V_{GE(th)}$	Gate-Emitter threshold voltage	$T_j=25^\circ\text{C}, V_{CE}=V_{GE}, I_C=2.0\text{mA}$	5.1	5.8	6.5	V	
$V_{CE(sat)}$	Collector-Emitter saturation voltage	$T_j=25^\circ\text{C}, V_{GE}=15\text{V}, I_C=50\text{A}$		2.0	2.35	V	
		$T_j=125^\circ\text{C}, V_{GE}=15\text{V}, I_C=50\text{A}$		2.4		V	
		$T_j=175^\circ\text{C}, V_{GE}=15\text{V}, I_C=50\text{A}$		2.5		V	
$Q_G$	Gate charge	$V_{GE}=\pm 15\text{V}$		235		$\mu\text{C}$	
$R_{Gint}$	Internal gate resistor	$T_j=25^\circ\text{C}$		2.6		$\Omega$	
$C_{ies}$	Input capacitance	$T_j=25^\circ\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		2990		pF	
$C_{res}$	Reverse Transfer Capacitance			130		pF	
$t_{(d)on}$	Turn-on time	$T_C=175^\circ\text{C}, V_{CC}=600\text{V}, I_C=50\text{A}, V_{GE}=\pm 15\text{V}, R_G=10\Omega$		30		ns	
$t_r$				33		ns	
$t_{(d)off}$	Turn-off time			256		ns	
$t_f$				58		ns	
$E_{on}$	Turn-on energy			5.3		mJ	
$E_{off}$	Turn-off energy			4.1		mJ	
$I_{sc}$	SC data		$V_{GE}\leq 15\text{V}, V_{CC}=600\text{V}, t_P\leq 10\mu\text{s}, T_{vj}=175^\circ\text{C}$		145		A
$t_{sc}$	Short circuit withstand time		$V_{CES}\leq 600\text{V}, V_{GE}=\pm 15\text{V}$			10	$\mu\text{s}$
$V_F$	Forward on voltage		$T_j=25^\circ\text{C}, I_F=50\text{A}, V_{GE}=0\text{V}$		1.9	2.3	V
		$T_j=125^\circ\text{C}, I_F=50\text{A}, V_{GE}=0\text{V}$		1.87		V	
		$T_j=175^\circ\text{C}, I_F=50\text{A}, V_{GE}=0\text{V}$		1.85		V	
$I_{RM}$	Peak reverse recovery current	$I_F=50\text{A}, -di_F/dt=1200\text{A}/\mu\text{s}, V_R=600\text{V}$		46		A	

$Q_r$	Recovered charge	$T_j=175^{\circ}\text{C}$		8.60		$\mu\text{C}$
$E_{\text{rec}}$	Reverse recovery energy			3.5		mJ
$t_{\text{rr}}$	Reverse recovery time			290		ns
$R_{\text{th}(j-c)}$	Thermal resistance(Junction-to-Case)	IGBT			0.22	$^{\circ}\text{C}/\text{W}$
		Diode			0.48	$^{\circ}\text{C}/\text{W}$
$R_{\text{th}(j-A)}$	Thermal resistance(Junction-to-Ambien)			42		$^{\circ}\text{C}/\text{W}$
Outline	TO-247P					

TECHSEM

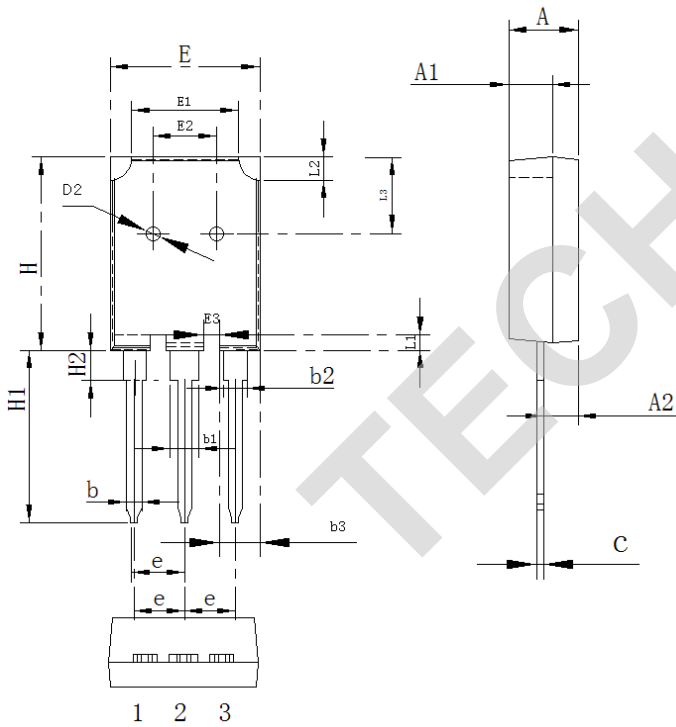






Outline:

TO-247P PACKAGE



Symbol	单位 mm		
	Min	Nom	Max
A	4.80	5.00	5.20
A1	2.80	3.0	3.20
A2	1.80	2.0	2.20
b	1.00	1.20	1.40
b1	2.90	3.10	3.30
b2	1.90	2.10	2.30
b3	3.90	4.10	4.30
c	0.45	0.60	0.75
e	5.25	5.45	5.65
E	15.6	15.8	16.0
E1	10.2	10.6	11.0
E2	6.30	6.06	6.90
E3	1.60	1.80	2.00
L1	0.35	0.50	0.65
L2	1.80	2.00	2.20
L3	9.50	10.0	10.5
H	20.5	21.0	21.5
H1	19.5	20.0	20.5
H2	3.50	4.00	4.50